

SPECIFICATION

Chip Antenna 3216 Size

2400-2500 MHz

P/N: HM3216ANT2450-HM3B

1. Frequency

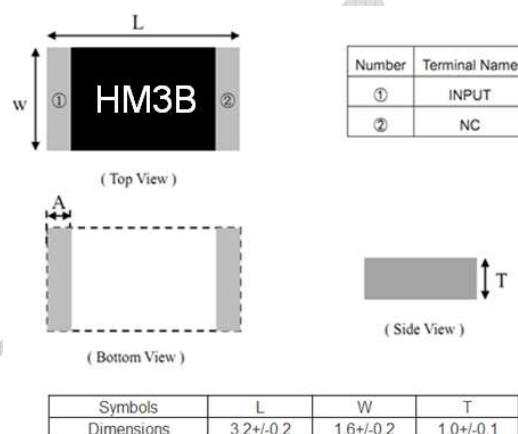
2400-2500 MHz

2. Applications

For Miniaturized Bluetooth System

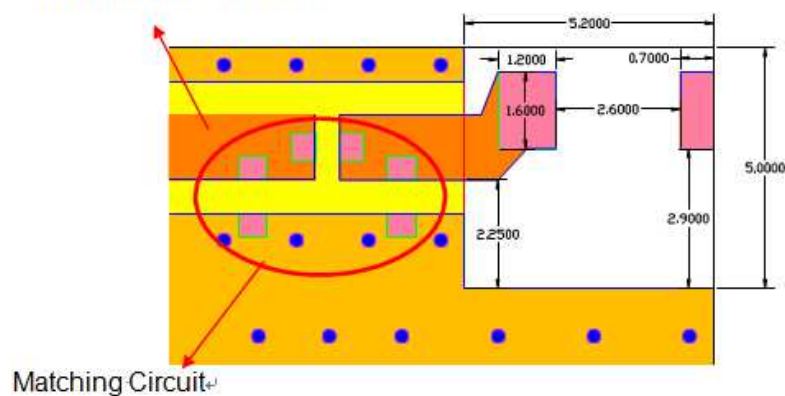
3. Dimensions (Unit : mm)

1). Over View :

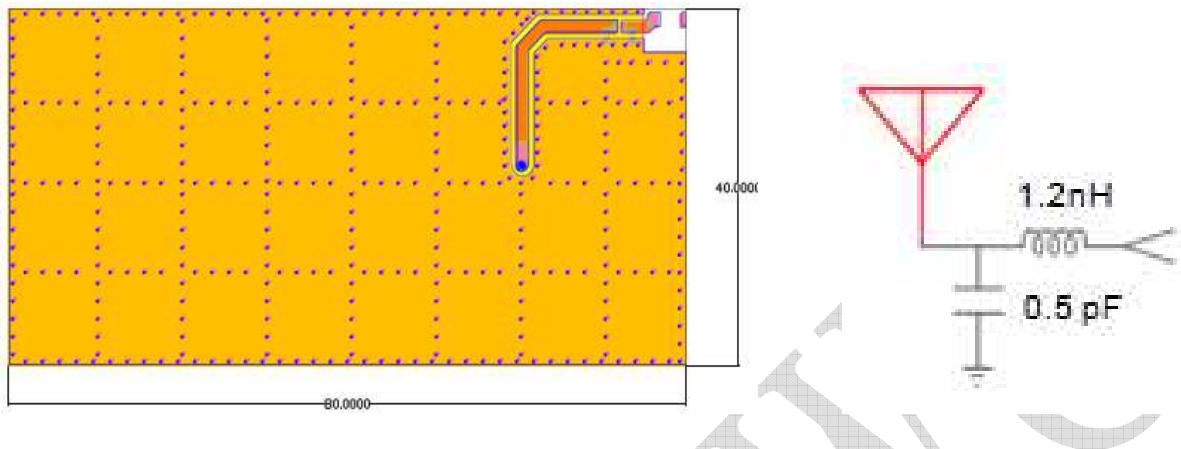


2). PCB Layout (Unit : mm) :

50 ohm transmission Line



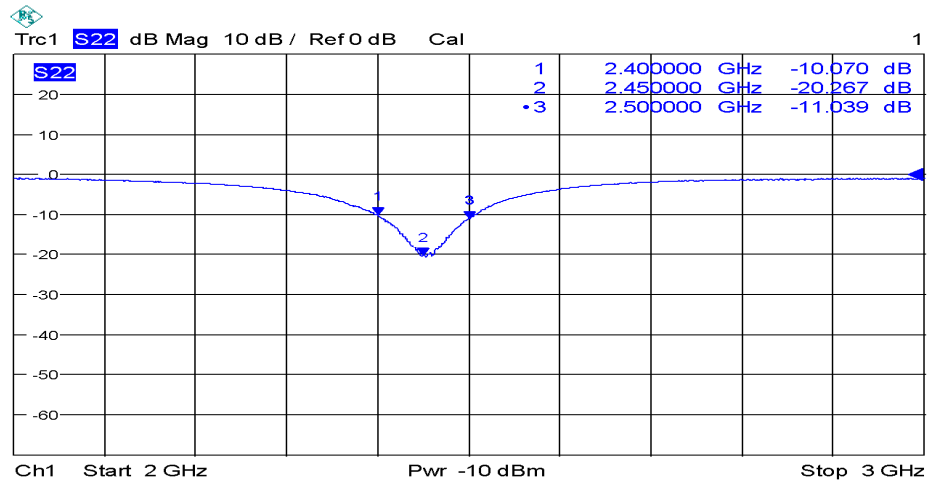
4. Evaluation Board Size and Matching Circuits



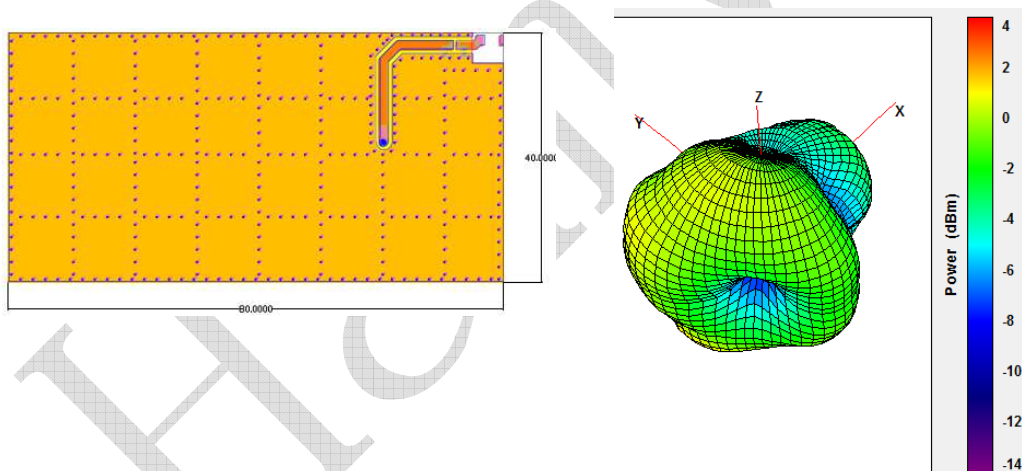
5. Electrical Characteristics

Part Number	HM3216ANT2450-HM3B
Central Frequency	2450 MHz
Bandwidth	100(typ.) MHz
V.S.W.R	≤ 2.0
Peak Gain	5.12 dBi
Impedance	50 Ohm
Polarization	Linear
Azimuth Beamwidth	Omni-directional

6. Return Loss (S11)

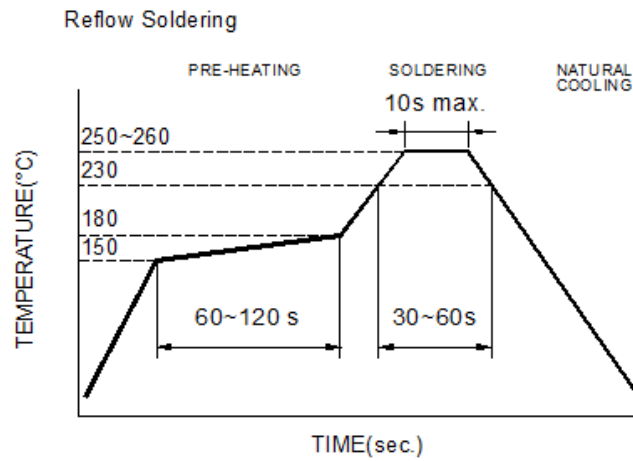


7. Radiation Pattern & Efficiency



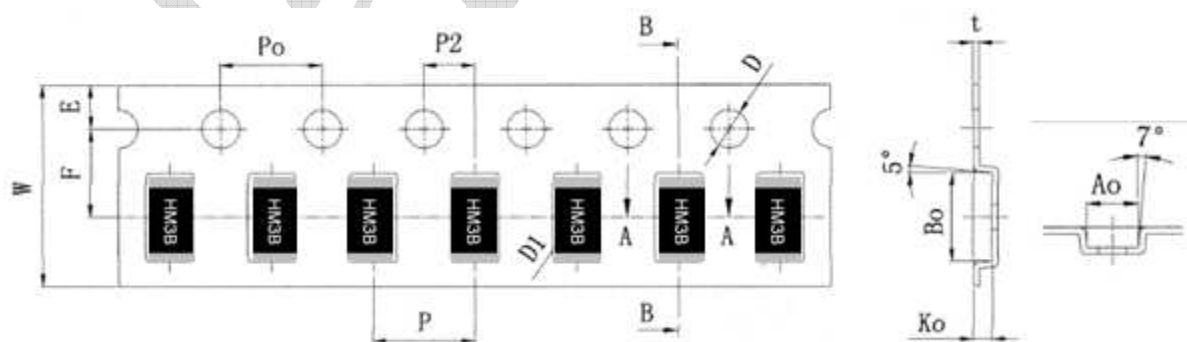
Frequency (MHz)	2400	2450	2500
Efficiency (dB)	-1.94	-1.55	-2.01
Efficiency (%)	64	70	63
Gain (dBi)	4.24	5.12	3.77

8. Reflow Soldering Standard Condition



9. Packaging and Dimensions

- Plastic Tape

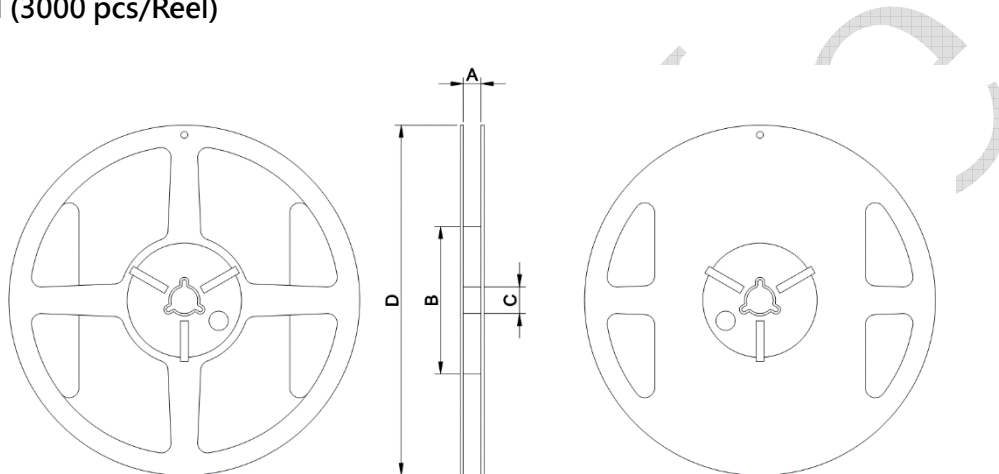


W	Ao	Bo	Ko	P	F	E	D	D1	Po	P2	t
8.0 ±0.30	1.80 ±0.05	3.51 ±0.10	1.59 ±0.10	4.00 ±0.05	3.50 ±0.05	1.75 ±0.10	1.50 ±0.10	0.00 ±0.10	4.00 ±0.10	2.00 ±0.05	0.25 ±0.05

- **Remarks for Package**

Reserve a length of 150~200mm for the trailer of the carrier and 250~300 mm for the leader of the carrier and further 250mm of cover tape at the leading part of the carrier.

- **Reel (3000 pcs/Reel)**



Tape Width(mm)	A(mm)	B(mm)	C(mm)	D(mm)	Chip/Reel(pcs)
8	9.0±0.5	60±2	13.5±0.5	178±2	3000

- **Storage Period**

Oxidizable Material, 12 months in vacuum sealed bag, please repack within 168 hours by re-seal the package treatment after using.

Storage Temperature Range : <30 degree C, Humidity : <60%RH

10. Dependability Test

Test item	Test condition / Test method	Specification
Solderability IEC 60068-2-58 GB/T2423.28	*Solder bath temperature : $240\pm 5^{\circ}\text{C}$ *Immersion time : 2 ± 0.5 sec Solder : Sn96.5Ag3.0Gu0.5 for lead-free.	At least 95% of a surface of each terminal electrode must be covered by fresh solder.
Leaching (Resistance to dissolution of metallization) JIS C5101	*Solder bath temperature : $260\pm 5^{\circ}\text{C}$ *Leaching immersion time : 10 ± 1 sec Solder : Sn96.5 Ag3.0 Gu0.5 for lead-free.	Loss of metallization on the edges of each electrode shall not exceed 25%.
Resistance to soldering heat IEC 60068-2-58 GB/T2423.28	*Preheating temperature : $120\sim 150^{\circ}\text{C}$, 1 minute. *Solder temperature : $260\pm 5^{\circ}\text{C}$ *Immersion time : 10 ± 1 sec Solder : Sn96.5Ag3.0Gu0.5 for lead-free Measurement to be made after keeping at room temperature for 24 ± 2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature. Loss of metallization on the edges of each electrode shall not exceed 25%.
Drop Test IEC 60068-2-32 GB/T2423.8 Customer' s specification.	*Height : 50 cm *Test Surface: Rigid surface of concrete or steel. *Times : 6 surfaces for each units ; 2 times for each side.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
Vibration IEC 60068-2-6 GB/T 2423.10	*Frequency : $10\text{Hz}\sim 55\text{Hz}\sim 10\text{Hz}(1\text{min})$ *Total amplitude : 1.5mm *Test times : 6hrs.(Two hrs each in three mutually perpendicular directions)	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
Adhesive Strength of Termination IEC60068-2-21 GB/T 2423.6	*Pressurizing force : $5\text{N}(\leq 0603)$; $10\text{N}(> 0603)$ *Test time: 10 ± 1 sec	No remarkable damage or removal of the termination.

Bending test IEC 60068-2-21 GB/T 2423.29	The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1 mm/s per second until the deflection becomes 2mm and then pressure shall be maintained for 10±1 sec. Measurement to be made after keeping at room temperature for 24±2 hours.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
Temperature cycle IEC60068-2-14 GB/T 2423.22	30 minutes at -40°C±2°C. 10~15 minutes at room temperature. 30minutes at +85°C±2°C. 10~15 minutes at room temperature. Total 100 continuous cycles Measurement to be made after keeping at room temperature for 24±2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
High temperature IEC 60068-2-2 GB/T2423.2	*Temperature : 85±2°C. *Test duration : 500+24/-0 hours. Measurement to be made after keeping at room temperature for 24±2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics.
Humidity (steady conditions) IEC60068-2-3 GB/T 2423.3	*Humidity : 85±5%R.H. *Temperature : 85±2°C. *Time : 500+24/-0 hrs. Measurement to be made after keeping at room temperature for 24±2 hrs ※ 200hrs measuring the first data then 300hrs data.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
Low temperature IEC 60068-2-1 GB/T2423.1	*Temperature : -40±2°C. *Test duration : 500+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.